# 2SK1626, 2SK1627

## Silicon N-Channel MOS FET

# **HITACHI**

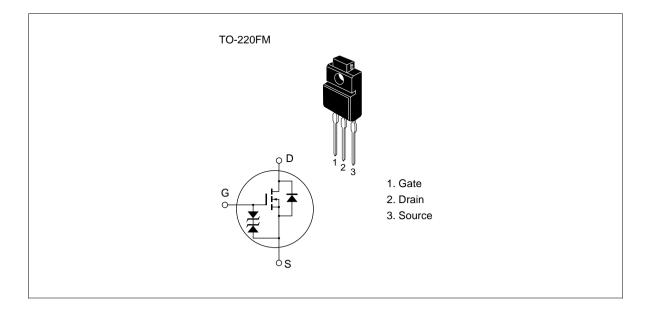
### **Application**

High speed power switching

#### **Features**

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

#### **Outline**





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## **Absolute Maximum Ratings** (Ta = 25°C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1626	V <sub>DSS</sub>	450	V
	2SK1627		500	
Gate to source voltage		$V_{\sf GSS}$	±30	V
Drain current		I <sub>D</sub>	5	А
Drain peak current		I <sub>D(pulse)</sub> *1	20	А
Body to drain diode reverse	e drain current	I <sub>DR</sub>	5	А
Channel dissipation		Pch*2	35	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Note

- 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%
- 2. Value at  $T_c = 25^{\circ}C$

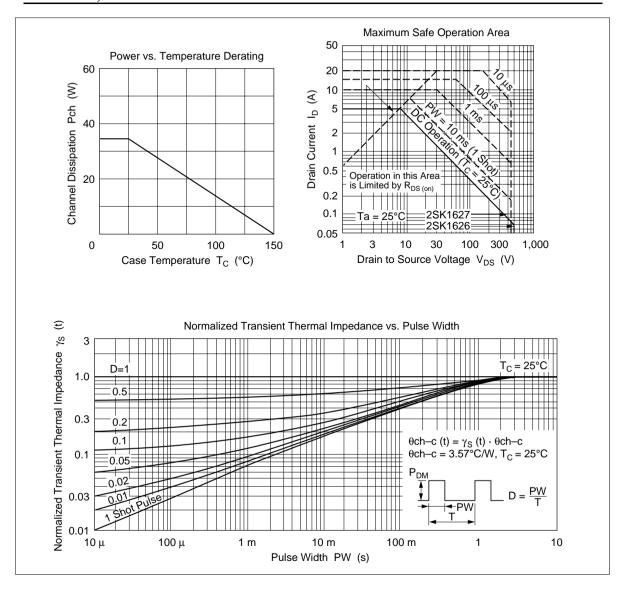
## **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

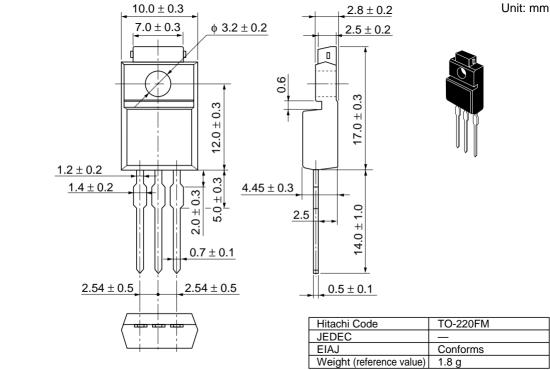
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SK1626	$V_{(BR)DSS}$	450	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
breakdown voltage	2SK1627	-	500	_			
Gate to source breakdown voltage		$V_{(BR)GSS}$	±30	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current		I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage	2SK1626	I <sub>DSS</sub>	_	_	250	μΑ	$V_{DS} = 360 \text{ V}, V_{GS} = 0$
drain current	2SK1627	-					$V_{DS} = 400 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage		$V_{\rm GS(off)}$	2.0	_	3.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static Drain to source	2SK1626	R <sub>DS(on)</sub>	_	1.0	1.4	Ω	$I_D = 2.5 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$
on state resistance	2SK1627	-	_	1.2	1.5	-	
Forward transfer admittance		yfs	2.5	4.0	_	S	$I_D = 2.5 \text{ A}, V_{DS} = 10 \text{ V}^{*1}$
Input capacitance		Ciss	_	640	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance		Coss	_	160	_	pF	f = 1 MHz
Reverse transfer capacitance		Crss	_	20	_	pF	_
Turn-on delay time		t <sub>d(on)</sub>	_	10	_	ns	$I_D = 2.5 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time		t <sub>r</sub>	_	25	_	ns	$R_L = 12 \Omega$
Turn-off delay time		t <sub>d(off)</sub>	_	50	_	ns	-
Fall time		t <sub>f</sub>	_	30	_	ns	-
Body to drain diode forward voltage		$V_{DF}$		0.95		V	$I_F = 5 A, V_{GS} = 0$
Body to drain diode reverse recovery time		t <sub>rr</sub>	_	300	_	ns	$I_F = 5 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A/}\mu\text{s}$

Note 1. Pulse test

See characteristic curves of 2SK1155, 2SK1156.

## 2SK1626, 2SK1627





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